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THE 35TH IEEE INTERNATIONAL CONFERENCE ON MICRO ELECTRO MECHANICAL SYSTEMS



MEMS 2022

TOKYO JAPAN

HYBRID

9-13 JANUARY, 2022

BENEFACTOR OPPORTUNITIES

CONFERENCE CHAIRS

Zhihong Li
Peking University, CHINA

Shuji Tanaka
Tohoku University, JAPAN

HYBRID LOCATIONS

- In-Person – Tokyo International Forum
- Virtual Conference App – Event Pilot
- Virtual Exhibits & Posters – Gather.Town



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THE 35TH IEEE INTERNATIONAL CONFERENCE ON MICRO ELECTRO MECHANICAL SYSTEMS



MEMS 2022

TOKYO JAPAN

HYBRID

9-13 JANUARY, 2022

ON BEHALF of the Organizing committee for the 35th International Conference on Micro Electro Mechanical Systems (IEEE MEMS 2022) we invite you to begin your preparations to attend and support MEMS 2022 planned for 9 - 13 January 2022 in Tokyo, Japan. We are excited to have secured a prestigious venue in an exceptional location for the meeting, and are preparing a meeting that will deliver technological innovation, opportunities for collaboration and learning, as well as experiences that you'll always remember.

LOCATED IN the center of Tokyo, the Tokyo International Forum provides a perfect space for our meeting, easily accessible for the industries and research institutions, it is the venue befitting to host the first MEMS conference in Tokyo.

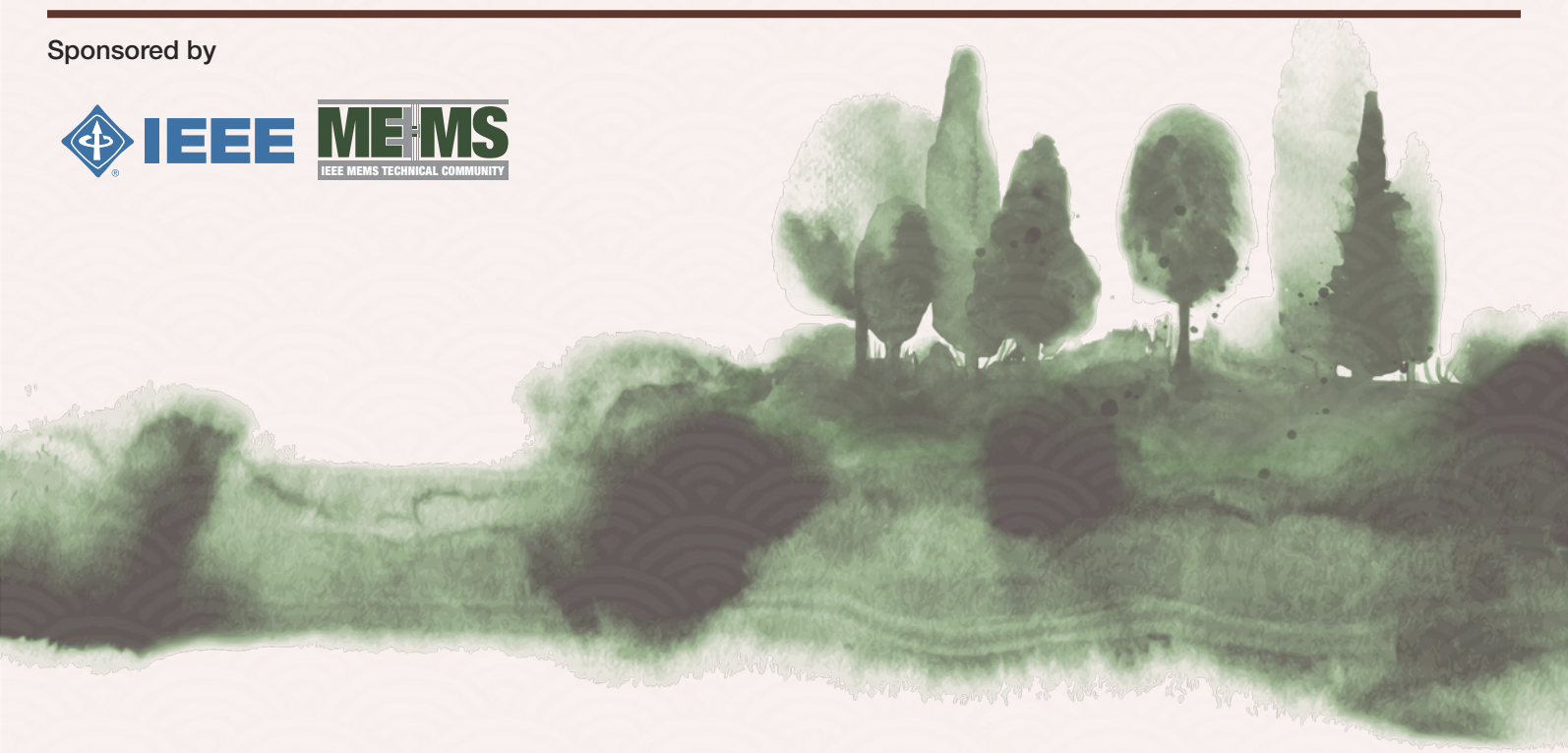
MEMS 2022 is seeking Benefactors, and we encourage you to begin planning to attend and support the meeting. You will find the details for participating in the meeting, and we encourage you to ask us any questions that come to mind. This unique venue and opportunity have us thinking creatively about this meeting, so if you have any ideas you'd like to suggest for innovative ways to engage with the meeting, please don't hesitate to contact all of us.

AS WE are still uncertain about Covid-19 situation in January 2022, we have devised some creative solution to reach the audience participating in the conference remotely. We hope you consider these options too.

Please feel free to contact us for any questions.

Zhihong Li - Peking University, China
Shuji Tanaka - Tohoku University, Japan
CONFERENCE CHAIRS, MEMS 2022

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BENEFACTOR LEVELS

GOLD \$5,000

- Banner Included in the Daily Email Schedule with Link to Company Website
- Full Page Ad in Electronic Final Program
- Presentation Banner on Random Rotation Throughout the Week on Session Pages in Virtual Conference App
- Two (2) Complimentary Full Registrations (good for in-person or virtual)
- Virtual Benefactor Poster Presentation in the Conference Platform Gather.Town²
- Virtual Exhibit Booth in the Conference Platform Gather.Town
- 1-Minute Video (mp4) that You Prepare, Played at Least One (1) Time During the Conference Before a Session Begins
- Company Logo on the Zoom Virtual Background that Presenters may use
- Company Name Listed in the Technical Digest¹
- Company Name and Logo in the Final Program¹
- Company Name on the Welcome sign¹
- Company Name and Logo on the Conference Website with a Link to Your Website
- Company Name and Logo on the Opening Slide at the Conference

SILVER \$2,500

- Presentation Banner on Random Rotation Throughout the Week on Session Pages in Virtual Conference App
- One (1) Complimentary Full Registration (good for in-person or virtual)
- Virtual Benefactor Poster Presentation in the Conference Platform Gather.Town²
- Virtual Exhibit Booth in the Conference Platform Gather.Town
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BRONZE \$1,000

- One (1) Complimentary Full Registration (good for in-person or virtual)
- Virtual Exhibit Booth in the Conference Platform Gather.Town
- Company Logo on the Zoom Virtual Background that Presenters may use
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¹Contract must be received by 15 December to ensure inclusion in marketing material.

²Contract must be received by 9 November. Contracts received after this date will not include Benefactor Poster

CONTRACT APPLICATION

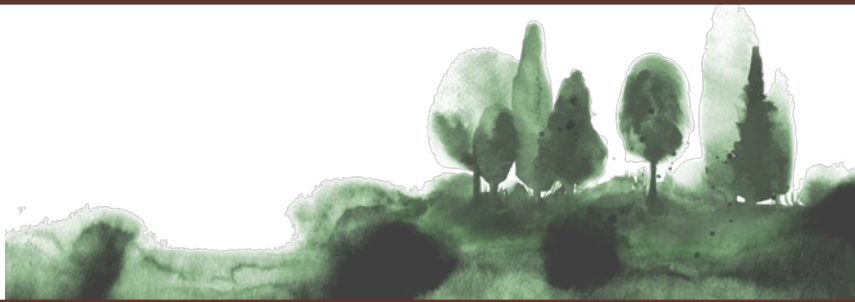


MEMS 2022 TOKYO JAPAN

The undersigned APPLICANT, agreeing to be legally bound hereby, applies for a benefactor level in the 35th IEEE International Conference on Micro Electro Mechanical Systems (MEMS). The MEMS Conference, upon its written acceptance of this Application, is to assign contribution benefits to the Applicant under all of the terms, conditions, and requirements as aforesaid. Applicant applies for one of the available benefactor levels at the fee indicated below. Contributions will be assigned on a first-come first-served basis.

BENEFACTOR LEVELS

- | | |
|---------------------------------|---------|
| <input type="checkbox"/> GOLD | \$5,000 |
| <input type="checkbox"/> SILVER | \$2,500 |
| <input type="checkbox"/> BRONZE | \$1,000 |



PROGRAM LISTING Information as it should appear on Website.

Company: _____

Mailing Address: _____

City: _____ State: _____ Zip: _____ Country: _____

Phone: _____

Company Email: _____ ie: info@ieeemems2022.org

Website: _____ *Must indicate url type: http:// https://*

CONTACT PERSON

Contact Name: _____

Phone: _____ Email: _____

Signature: _____ Position: _____

PAYMENT INFORMATION

Bank Wire Transfer (Bank wire transfer information will be sent to you upon receipt of this contract)

Credit Card Payment VISA MasterCard American Express

TOTAL

\$ _____

Cardholder Signature: _____

Card Number: _____ Expiration date: _____ Verification Code: _____

Billing Address: _____

City: _____ State: _____ Zip: _____ Country: _____

Please complete form and return with payment to:

IEEE MEMS 2022 c/o PMMI, 307 Laurel Street, San Diego, CA 92101-1630 USA Phone: +1-619-232-9499, Fax: +1-619-232-0799, Email: exhibits@ieeemems2022.org

Cancellation Policy

- A Contributor wishing to cancel their contribution prior to 18 November 2021 and after their signed application has been received will be refunded 50%
- Cancellations after that time will not receive a refund • All cancellation notices must be made in writing